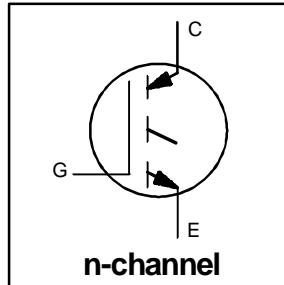


### Features

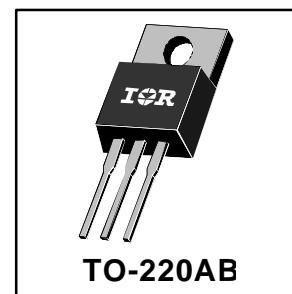
- Switching-loss rating includes all "tail" losses
  - Optimized for high operating frequency (over 5kHz)
- See Fig. 1 for Current vs. Frequency curve



$V_{CES} = 500V$   
 $V_{CE(sat)} \leq 3.0V$   
 @  $V_{GE} = 15V$ ,  $I_C = 22A$

### Description

Insulated Gate Bipolar Transistors (IGBTs) from International Rectifier have higher usable current densities than comparable bipolar transistors, while at the same time having simpler gate-drive requirements of the familiar power MOSFET. They provide substantial benefits to a host of high-voltage, high-current applications.



### Absolute Maximum Ratings

	Parameter	Max.	Units
$V_{CES}$	Collector-to-Emitter Voltage	500	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	40	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	22	
$I_{CM}$	Pulsed Collector Current ①	80	
$I_{LM}$	Clamped Inductive Load Current ②	80	
$V_{GE}$	Gate-to-Emitter Voltage	$\pm 20$	V
$E_{ARV}$	Reverse Voltage Avalanche Energy ③	15	mJ
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	160	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	65	
$T_J$ $T_{STG}$	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ C$
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf-in (1.1N-m)	

### Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	—	0.77	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.50	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	80	
Wt	Weight	—	2.0 (0.07)	—	g (oz)

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

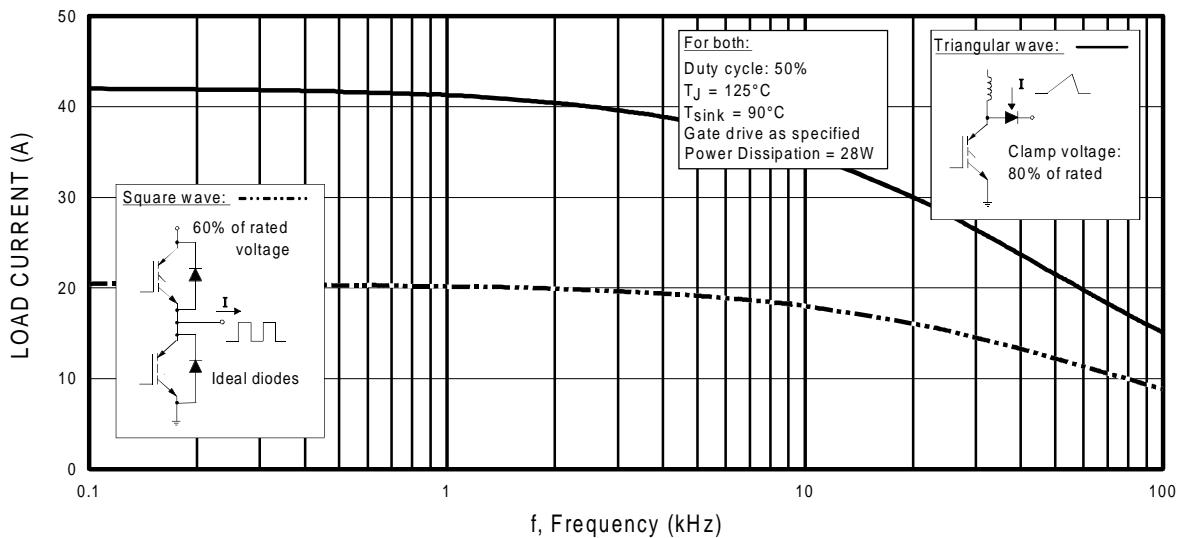
	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage	500	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 250\mu\text{A}$
$V_{(\text{BR})\text{ECS}}$	Emitter-to-Collector Breakdown Voltage <sup>④</sup>	20	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.35	—	$\text{V}/^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{mA}$
$V_{\text{CE}(\text{on})}$	Collector-to-Emitter Saturation Voltage	—	2.4	3.0	V	$I_C = 22\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	2.8	—		$I_C = 40\text{A}$ See Fig. 2, 5
		—	2.4	—		$I_C = 22\text{A}, T_J = 150^\circ\text{C}$
		3.0	—	5.5		$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-11	—	$\text{mV}/^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
$g_{\text{fe}}$	Forward Transconductance <sup>⑤</sup>	6.6	13	—	S	$V_{\text{CE}} = 100\text{V}, I_C = 22\text{A}$
$I_{\text{CES}}$	Zero Gate Voltage Collector Current	—	—	250	$\mu\text{A}$	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 500\text{V}$
		—	—	1000	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 500\text{V}, T_J = 150^\circ\text{C}$	
$I_{\text{GES}}$	Gate-to-Emitter Leakage Current	—	—	$\pm 100$	nA	$V_{\text{GE}} = \pm 20\text{V}$

**Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

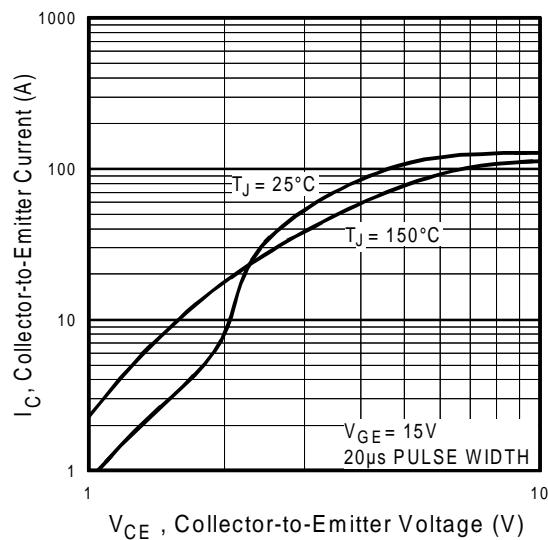
	Parameter	Min.	Typ.	Max.	Units	Conditions
$Q_g$	Total Gate Charge (turn-on)	—	55	83	nC	$I_C = 22\text{A}$
$Q_{ge}$	Gate - Emitter Charge (turn-on)	—	11	17		$V_{\text{CC}} = 400\text{V}$ See Fig. 8
$Q_{gc}$	Gate - Collector Charge (turn-on)	—	19	29		$V_{\text{GE}} = 15\text{V}$
$t_{d(\text{on})}$	Turn-On Delay Time	—	27	—	ns	$T_J = 25^\circ\text{C}$
$t_r$	Rise Time	—	13	—		$I_C = 22\text{A}, V_{\text{CC}} = 400\text{V}$
$t_{d(\text{off})}$	Turn-Off Delay Time	—	100	150		$V_{\text{GE}} = 15\text{V}, R_G = 10\Omega$
$t_f$	Fall Time	—	56	100		Energy losses include "tail"
$E_{\text{on}}$	Turn-On Switching Loss	—	0.37	—	mJ	See Fig. 9, 10, 11, 14
$E_{\text{off}}$	Turn-Off Switching Loss	—	0.18	—		
$E_{ts}$	Total Switching Loss	—	0.55	0.70		
$t_{d(\text{on})}$	Turn-On Delay Time	—	27	—	ns	$T_J = 150^\circ\text{C},$ $I_C = 22\text{A}, V_{\text{CC}} = 400\text{V}$
$t_r$	Rise Time	—	15	—		$V_{\text{GE}} = 15\text{V}, R_G = 10\Omega$
$t_{d(\text{off})}$	Turn-Off Delay Time	—	137	—		Energy losses include "tail"
$t_f$	Fall Time	—	100	—		See Fig. 10, 14
$E_{ts}$	Total Switching Loss	—	0.96	—	mJ	Measured 5mm from package
$L_E$	Internal Emitter Inductance	—	7.5	—	nH	
$C_{\text{ies}}$	Input Capacitance	—	1400	—	pF	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CC}} = 30\text{V}$ See Fig. 7 $f = 1.0\text{MHz}$
$C_{\text{oes}}$	Output Capacitance	—	250	—		
$C_{\text{res}}$	Reverse Transfer Capacitance	—	42	—		

**Notes:**

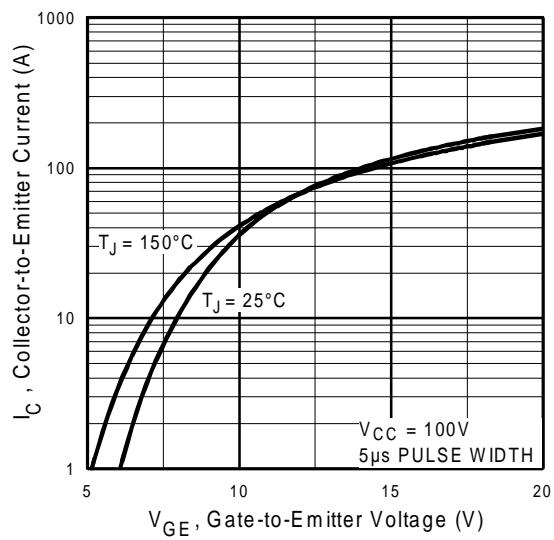
- ① Repetitive rating;  $V_{\text{GE}}=20\text{V}$ , pulse width limited by max. junction temperature.  
( See fig. 13b )
- ②  $V_{\text{CC}}=80\%(V_{\text{CES}})$ ,  $V_{\text{GE}}=20\text{V}$ ,  $L=10\mu\text{H}$ ,  $R_G=10\Omega$ , ( See fig. 13a )
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width  $\leq 80\mu\text{s}$ ; duty factor  $\leq 0.1\%$ .
- ⑤ Pulse width  $5.0\mu\text{s}$ , single shot.



**Fig. 1 - Typical Load Current vs. Frequency**  
 (For square wave,  $I=I_{RMS}$  of fundamental; for triangular wave,  $I=I_{PK}$ )

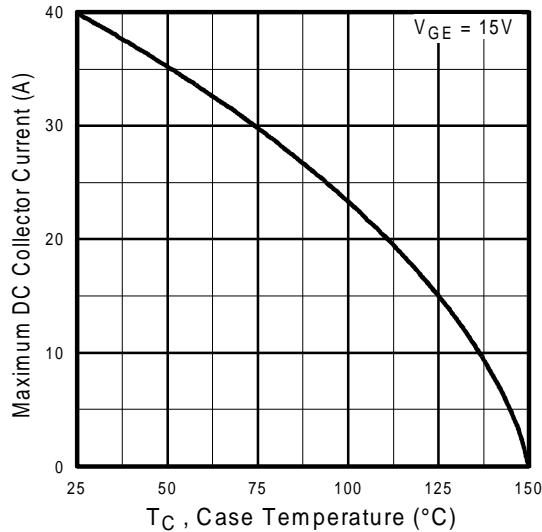


**Fig. 2 - Typical Output Characteristics**

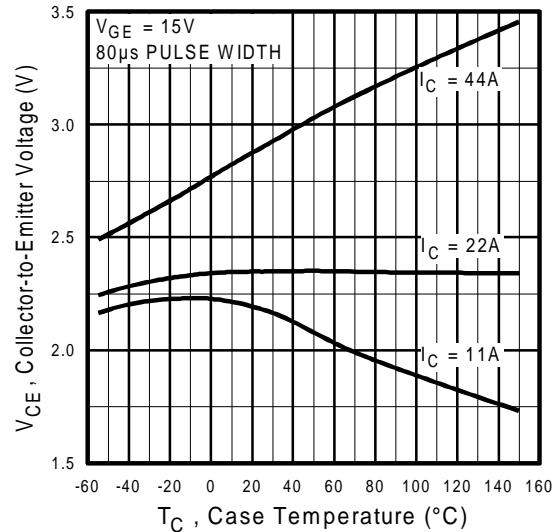


**Fig. 3 - Typical Transfer Characteristics**

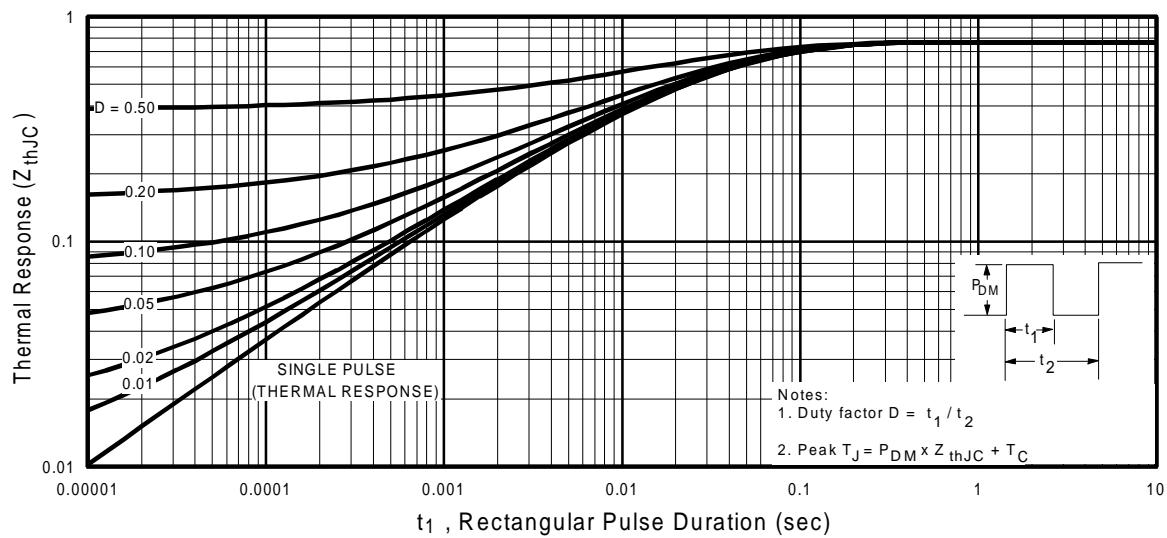
# IRGB440U



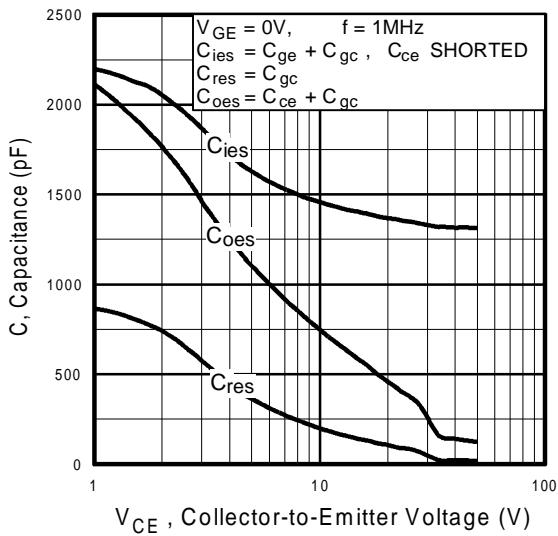
**Fig. 4 - Maximum Collector Current vs. Case Temperature**



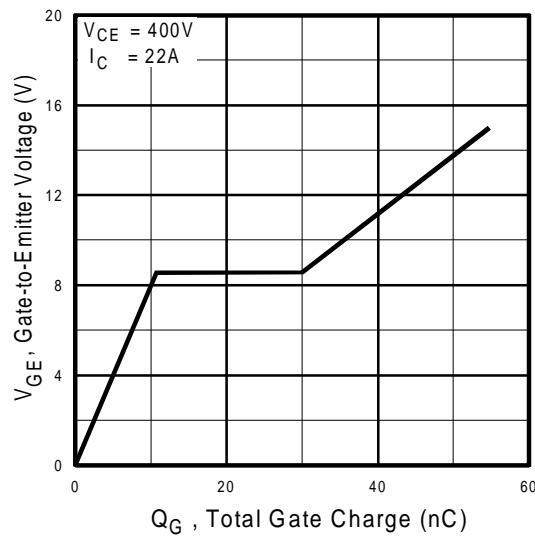
**Fig. 5 - Collector-to-Emitter Voltage vs. Case Temperature**



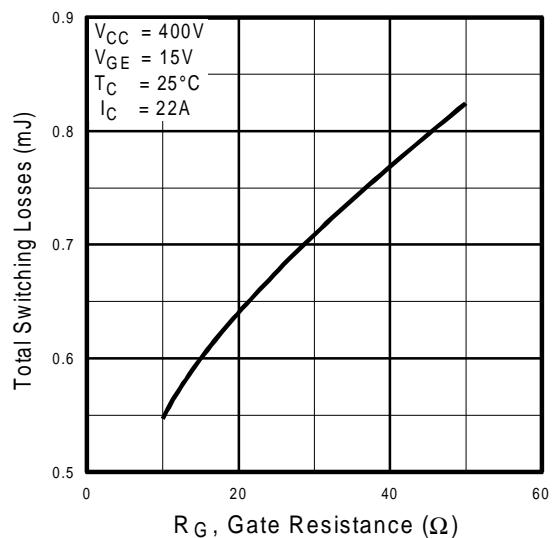
**Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**



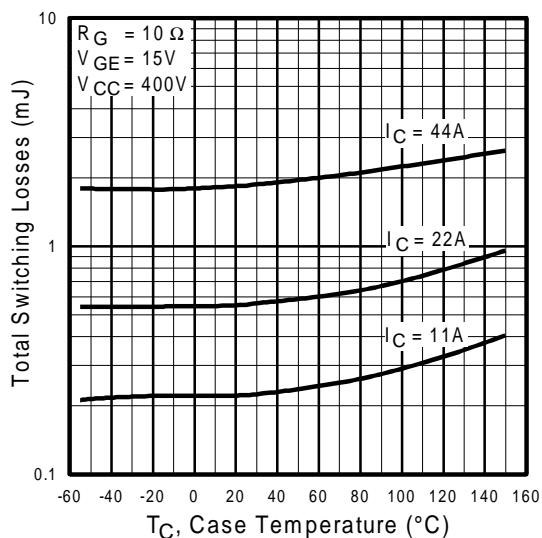
**Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage**



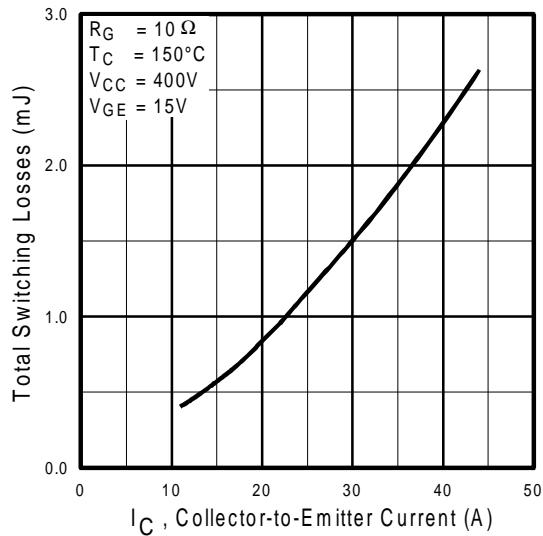
**Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage**



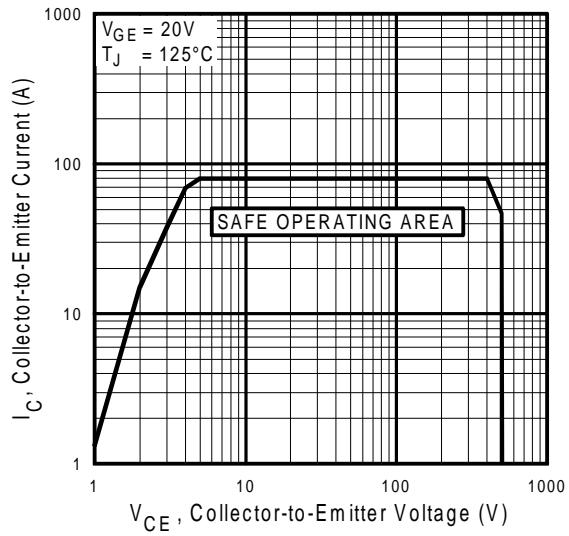
**Fig. 9 - Typical Switching Losses vs. Gate Resistance**



**Fig. 10 - Typical Switching Losses vs. Case Temperature**



**Fig. 11** - Typical Switching Losses vs.  
Collector-to-Emitter Current



**Fig. 12** - Turn-Off SOA

Refer to Section D for the following:

**Appendix A: Section D - page D-3**

- Fig. 13a - Clamped Inductive Load Test Circuit
- Fig. 13b - Pulsed Collector Current Test Circuit
- Fig. 14a - Switching Loss Test Circuit
- Fig. 14b - Switching Loss Waveform

**Package Outline 1** - JEDEC Outline TO-220 AB

**Section D - page D-12**